Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	60	((anti-corros$6 or (anti adj corros$6)) adj treat$8) and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/29 13:25
L2	29	1 and @ad<="20001120"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/29 13:26
L3	23	2 and (copper or ("Cu"))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/29 13:27
S1	1	("6146468").PN.	USPAT; USOCR	OR	OFF	2004/07/23 13:39
S2	2	((("6329298") or ("4668335")).PN.	USPAT; USOCR	OR	OFF	2003/11/26 14:10
S3	581	438/687	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/14 09:10
S4	0	438/687 and (anti-corrosion adj treat$5)	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/05 12:48
S5	0	438/687 and ((anti-corrosion or (corros$5 adj inhibit$5)) adj treat$5)	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/10/21 13:59
S6	0	438/687 and ((corros$5 adj inhibit$5) adj treat$5)	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/14 09:17
S7	2	(((corros$5 adj inhibit$5) adj treat$5)) and semiconductor	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/05 12:50
S8	16	(anti-corrosion adj treat$5) and semiconductor	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/05 12:50
S9	18	(((anti-corrosion or (corros$5 adj inhibit$5)) adj treat$5)) and semiconductor	USPAT; EPO; JPO; DERWENT	OR	OFF	2003/11/20 07:51
S10	186	((corros$5 adj inhibit$5) adj treat$5)	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/05 12:56
S11	223	anti-corrosion adj treat$5	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/08/06 14:53

S12	407	((anti-corrosion or (corros$5 adj inhibit$5)) adj treat$5)	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/05 13:12
S13	3	(("6329298") or ("4668335") or ("6323131")).PN.	USPAT; USOCR	OR	OFF	2004/07/23 13:39
S14	5218	anti-corrosive	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/10/21 13:43
S15	946	anti-corrosive and copper	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/14 09:18
S16	450808	copper	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/10/21 13:57
S17	946	copper and anti-corrosive	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/14 09:28
S18	0	(copper and anti-corrosive) and (hetero-cyclic)	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/14 09:19
S19	2	(copper and anti-corrosive) and (hetero adj cyclic)	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/14 09:19
S20	0	((copper and anti-corrosive) and (hetero adj cyclic)) and (indazole)	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/14 09:29
S21	4	(copper and anti-corrosive) and (indazole)	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/14 09:24
S22	0	((copper and anti-corrosive) and (indazole)) and semiconductor	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/14 09:29
S23	2175	copper and ((anti-corrosive) or (anti adj corrosion))	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/14 10:28
S24	0	((copper and ((anti-corrosive) or (anti adj corrosion))) and (indazole)) and semiconductor	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/14 09:30
S25	12	(copper and ((anti-corrosive) or (anti adj corrosion))) and (indazole)	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/14 10:29
S26	171	(copper and ((anti-corrosive) or (anti adj corrosion))) and semiconductor	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/19 12:34
S27	0	((copper and ((anti-corrosive) or (anti adj corrosion))) and semiconductor) and (indazole)	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/14 10:02

S28	52420	copper and ((anticorros$3) or (corros$3))	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/14 10:29
S29	163	(copper and ((anticorros$3) or (corros$3))) and (indazole)	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/14 10:29
S30	20	((copper and ((anticorros$3) or (corros$3))) and (indazole)) and semiconductor	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/14 10:32
S31	16	((copper and ((anticorros$3) or (corros$3))) and (indazole)) and (interconnect$3 or wir$4 or (sheet adj metal))	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/14 14:37
S32	3	(("5391257") or ("5641381") or ("5455202")).PN.	USPAT; USOCR	OR	OFF	2002/02/14 14:38
S33	172	(copper and ((anti-corrosive) or (anti adj corrosion))) and semiconductor	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/19 12:39
S34	3	((copper and ((anti-corrosive) or (anti adj corrosion))) and semiconductor) and (SiON or (silicon adj oxygen adj nitrogen))	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/19 12:38
S35	2176	(copper and ((anti-corrosive) or (anti adj corrosion)))	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/19 12:38
S36	3	(((copper and ((anti-corrosive) or (anti adj corrosion)))) and (SiON or (silicon adj oxygen adj nitrogen))) and semiconductor	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/19 12:39
S37	23	((copper and ((anti-corrosive) or (anti adj corrosion)))) and (SiON or (silicon adj oxygen adj nitrogen))	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/02/19 12:39
S38	609	(438/687).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2002/08/06 14:53
S39	484110	copper	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2002/08/06 14:53
S40	836479	copper or ("cu")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2002/08/06 14:54

S41	235539	(copper or ("cu")) and treat$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2002/08/06 14:56
S42	4708	((copper or ("cu")) and treat$5) and (corros$5 adj (inhibit$5 or treat$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2002/08/06 14:58
S43	255	(((copper or ("cu")) and treat$5) and (corros$5 adj (inhibit$5 or treat$5))) and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2002/08/06 14:58
S44	38	((((copper or ("cu")) and treat$5) and (corros$5 adj (inhibit$5 or treat$5))) and semiconductor) and (anti-corros$5 or (anti adj corros$5))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2002/08/06 14:59
S45	1	("6274478").PN.	USPAT; USOCR	OR	OFF	2002/08/06 15:08
S46	0	((anti-corrosive or (anti adj corrosive)) adj treat$5) same ((copper-diffus$4 or (copper adj diffus$4)) adj (stop$5 or barrier) adj (layer or film))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2002/10/21 13:50
S47	129	(anti-corrosive or (anti adj corrosive)) adj treat$5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2002/10/21 14:55
S48	7	((anti-corrosive or (anti adj corrosive)) adj treat$5) and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/29 13:21
S49	483451	copper	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2002/10/21 13:58
S50	121	copper and ((anti-corrosion or (anti adj corros$4) or (corros$5 adj inhibit$5)) adj treat$5)	USPAT; EPO; JPO; DERWENT	OR	OFF	2002/10/21 14:01
S51	139	copper and ((anti-corrosion or (anti adj corros$4) or (corros$5 adj inhibit$5)) adj treat$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2002/10/21 14:01

S52	24	(copper and ((anti-corrosion or (anti adj corros$4) or (corros$5 adj inhibit$5)) adj treat$5)) and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/07/13 13:15
S53	0	(semiconductor adj substrate) same ((anti-corrosive or (anti adj corrosive)) adj treat$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2002/10/21 14:56
S54	1	("6350687").PN.	USPAT; USOCR	OR	OFF	2002/10/22 14:23
S55	0	("jp11003892").PN.	USOCR; JPO	OR	OFF	2002/10/22 13:07
S56	3	(("6350687") or ("5670421") or ("6323131")).PN.	USPAT; USOCR	OR	OFF	2002/10/22 14:24
S57	57	(((anticorros$5 or anti-corros$5 or (anti adj corros$5)) or (corros$5 adj inhibit$5)) adj (treat$5)) and semiconductor	USPAT; EPO; JPO; DERWENT	OR	OFF	2003/06/04 09:01
S58	79	(((anticorros$5 or anti-corros$5 or (anti adj corros$5)) or (corros$5 adj inhibit$5)) adj (treat$5)) and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/06/04 10:21
S59	1	(((anticorros$5 or anti-corros$5 or (anti adj corros$5)) or (corros$5 adj inhibit$5)) adj (treat$5)) and ((cu or copper) adj (diffus$6 adj (barrier or stop$6))) and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/06/04 10:20
S60	1	(((anticorros$5 or anti-corros$5 or (anti adj corros$5)) or (corros$5 adj inhibit$5)) adj (treat$5)) and ((cu or copper) adj (diffus$6 adj (barrier or stop$6)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/06/04 10:20
S61	37	((((anticorros$5 or anti-corros$5 or (anti adj corros$5)) or (corros$5 adj inhibit$5)) adj (treat$5)) and semiconductor) and (cu or copper)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/06/04 10:21
S62	55	((((anticorros$5 or anti-corros$5 or (anti adj corros$5)) or (corros$5 adj inhibit$5)) adj (treat$5)) and semiconductor) and (cu or copper)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/06/04 10:21
S63	4	(("6329298") or ("6099598") or ("4985113") or ("5670421")).PN.	USPAT; USOCR	OR	OFF	2003/06/10 11:38
S64	5	(("6329298") or ("6099598") or ("4985113") or ("5670421") or ("6350687")).PN.	USPAT; USOCR	OR	OFF	2003/06/10 15:00

S65	1	("20020094602").PN.	US-PGPUB; USOCR	OR	OFF	2003/06/10 15:01
S66	21	(((anti-corrosion or (corros$5 adj inhibit$5)) adj treat$5)) and semiconductor and @ad<="20001120"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/11/20 07:54
S67	14	(((anti-corrosion or (corros$5 adj inhibit$5)) adj treat$5)) and semiconductor and @ad<="20001120" and copper	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/11/20 07:55
S68	1	("20030071355").PN.	US-PGPUB; USOCR	OR	OFF	2004/07/13 13:14
S69	18	(copper and ((anti-corrosion or (anti adj corros$4) or (corros$5 adj inhibit$5)) adj treat$5)) and semiconductor and @ad<="20001120"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/07/13 13:30
S70	8	(copper with ((anti-corrosion or (anti adj corros$4) or (corros$5 adj inhibit$5)) adj treat$5)) and semiconductor and @ad<="20001120"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/07/13 13:30
S71	9	(copper same ((anti-corrosion or (anti adj corros$4) or (corros$5 adj inhibit$5)) adj treat$5)) and semiconductor and @ad<="20001120"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/07/13 13:45
S72	18	(copper and ((anti-corrosion or (anti adj corros$4) or (corros$5 adj inhibit$5)) adj treat$5)) and semiconductor and @ad<="20001120"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/07/13 13:46
S73	12	(copper same ((anti-corros$4 or anticorros$4 or (anti adj corros$4) or (corros$5 adj inhibit$5)) adj treat$5)) and semiconductor and @ad<="20001120"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/07/13 13:47
S74	11	(copper with ((anti-corros$4 or anticorros$4 or (anti adj corros$4) or (corros$5 adj inhibit$5)) adj treat$5)) and semiconductor and @ad<="20001120"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/07/13 13:47
S75	26	(copper and ((anti-corros$4 or anticorros$4 or (anti adj corros$4) or (corros$5 adj inhibit$5)) adj treat$5)) and semiconductor and @ad<="20001120"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/07/13 13:47

S76	61349	(copper or ("cu")) and treat	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2002/08/06 14:55
S77	1	("6162741").PN.	USPAT; USOCR	OR	OFF	2002/10/22 08:59
S78	1	("20020098635").PN.	US-PGPUB; USOCR	OR	OFF	2003/06/04 13:14
S79	1	("5296716").PN.	USPAT; USOCR	OR	OFF	2003/06/10 13:56
S80	1	("6570186").PN.	USPAT; USOCR	OR	OFF	2003/11/20 08:44
S81	1	("6313526").PN.	USPAT; USOCR	OR	OFF	2003/11/26 14:10